

The Anatomy of an Efficient Blackwell GEMM

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Table of contents

Abstract	3
Acknowledgements	3
List of Figures and Tables	3
1 Chapter 1 – Introduction	5
1.1 Motivation and Context: The Need for Hardware–Software Co-Design	5
1.2 Challenges in Efficient Compute for AI and Edge Applications	5
1.3 Objectives and Scope of the Thesis	5
1.4 Methodology Overview	5
1.5 Structure of the Thesis	5
2 Chapter 2 – Background and Related Work	5
2.1 Evolution of GPU Architectures: From Volta to Blackwell	5
2.2 Hardware–Software Co-Design: Principles and Applications	5
2.3 General Matrix-Matrix Multiplication (GEMM) in AI Workloads	5
2.4 Domain-Specific Languages (DSLs) for GPU Programming	5
2.5 Relevant Publications and Tools (NVIDIA Research, Citadel, JAX Scaling Book, etc.)	5
3 Chapter 3 – Architecture Comparison: Hopper vs Blackwell	5
3.1 Overview of Hopper Architecture	5
3.2 Overview of Blackwell Architecture	5
3.3 Key Innovations in Blackwell	5
3.3.1 Ultra Tensor Cores and New Precision Formats (FP8, FP4)	5
3.3.2 Transformer Engine and FP4 Micro Scaling	5
3.3.3 Multi-Die Chip Design and Interconnect (NVLink, NVSwitch)	5
3.3.4 Memory System: HBM3e, L2 Cache, and Shared Memory	5
3.4 Performance/Watt and Area Efficiency Considerations	5

3.5	Summary of Architectural Differences	5
4	Chapter 4 – Metrics for GPU Efficiency	5
4.1	Performance per Watt	5
4.2	Compute Throughput by Data Type	5
4.3	Memory Bandwidth and Arithmetic Intensity	5
4.4	Power, Thermal Design, and Silicon Area Constraints	5
4.5	Efficiency Bottlenecks: From Memory Bound to Compute Bound	5
5	Chapter 5 – Programming Models for Modern GPUs	5
5.1	Introduction to GPU DSLs for Performance	5
5.2	Triton	5
5.3	ThunderKittens (TK)	5
5.4	TileLang	5
5.5	Cute and CUTLASS	5
5.6	Gluon	5
5.7	Pallas and the JAX ML Scaling Framework	5
5.8	Summary: DSLs as Enablers of Architectural Efficiency	5
6	Chapter 6 – Methodology and Experimental Setup	5
6.1	Objectives of Benchmarking	5
6.2	Hardware Platforms and Specifications	5
6.2.1	Hopper H100	5
6.2.2	Blackwell B200	5
6.3	Software Tools and Libraries Used	5
6.4	Microbenchmark Design: GEMM Kernel Implementations	5
6.5	Measurement Techniques	5
6.5.1	Throughput (FLOP/s)	5
6.5.2	Power Consumption and Efficiency	5
6.5.3	Memory Bandwidth	5
6.6	Ensuring Fairness and Reproducibility	5
7	Chapter 7 – Results and Discussion	5
7.1	Performance Comparison Across Data Types	5
7.2	Analysis of Performance per Watt	5
7.3	Memory Bandwidth Observations	5
7.4	Impact of TMA (Tensor Memory Accelerator)	5
7.5	Roofline Analysis: Compute vs Memory Bound	5
7.6	Real-World Relevance: Case Study on Transformer Inference/Training	5
7.7	Discussion of Bottlenecks and Architectural Impact	5
8	Chapter 8 – Conclusions and Future Work	5
8.1	Summary of Findings	5

8.2	Implications for Hardware–Software Co-Design	5
8.3	Relevance to Edge Computing	5
8.4	Future Work and Doctoral Research Directions	5
9	References	5
10	Appendices	5
10.1	Appendix A: Experimental Scripts and Kernel Listings	5
10.2	Appendix B: Extended Benchmark Results	5
10.3	Appendix C: TMA and GEMM Intrinsics Documentation	5

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Acknowledgements

List of Figures and Tables

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1 Chapter 1 – Introduction

1.1 Motivation and Context: The Need for Hardware–Software Co-Design

1.2 Challenges in Efficient Compute for AI and Edge Applications

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2.1 Evolution of GPU Architectures: From Volta to Blackwell

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3.1 Overview of Hopper Architecture

3.2 Overview of Blackwell Architecture

3.3 Key Innovations in Blackwell

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3.3.2 Transformer Engine and FP4 Micro Scaling

3.3.3 Multi-Die Chip Design and Interconnect (NVLink, NVSwitch)

3.3.4 Memory System: HBM3e, L2 Cache, and Shared Memory

3.4 Performance/Watt and Area Efficiency Considerations

3.5 Summary of Architectural Differences

4 Chapter 4 – Metrics for GPU Efficiency

4.1 Performance per Watt

4.2 Compute Throughput by Data Type